Power MOSFET

Single N–Channel, 40 V, 1.4 m Ω , 200 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- LFPAK8 Package, Industry Standard
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	40	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	I _D	200	А	
Current R _{θJC} (Notes 1, 3)	State	T _C = 100°C		140		
Power Dissipation		T _C = 25°C	PD	110	W	
R _{θJC} (Note 1)		T _C = 100°C		53		
Continuous Drain Current R _{θJA}	Steady State	$T_A = 25^{\circ}C$	Ι _D	38	Α	
(Notes 1, 2, 3)	Sidle	T _A = 100°C		27		
Power Dissipation		T _A = 25°C	PD	3.8	W	
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.9		
Pulsed Drain Current	$T_A = 25^\circ C$, $t_p = 10 \ \mu s$		I _{DM}	900	А	
Operating Junction and Storage Temperature		T _J , T _{stg}	–55 to + 175	°C		
Source Current (Body Diode)			I _S	120	А	
Single Pulse Drain-to-S Energy (I _{L(pk)} = 15 A)	Source Av	alanche	E _{AS}	493	mJ	
Single Pulse Drain-to-S (t _p = 10 μs)	le Pulse Drain–to–Source Voltage 10 μs)		V _{DSM}	48	V	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.4	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	36	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

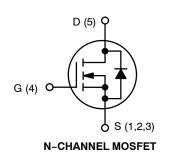
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

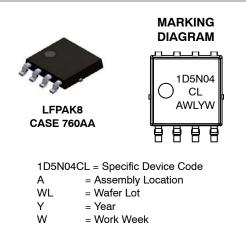


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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.4 mΩ @ 10 V	200 A
40 V	2.2 mΩ @ 4.5 V	200 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

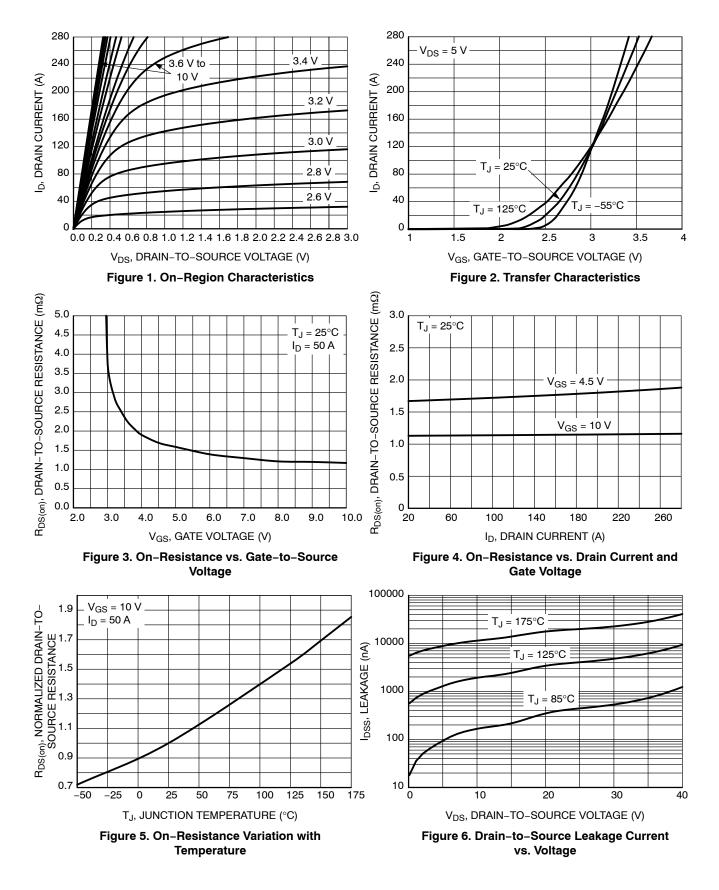
^{2.} Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

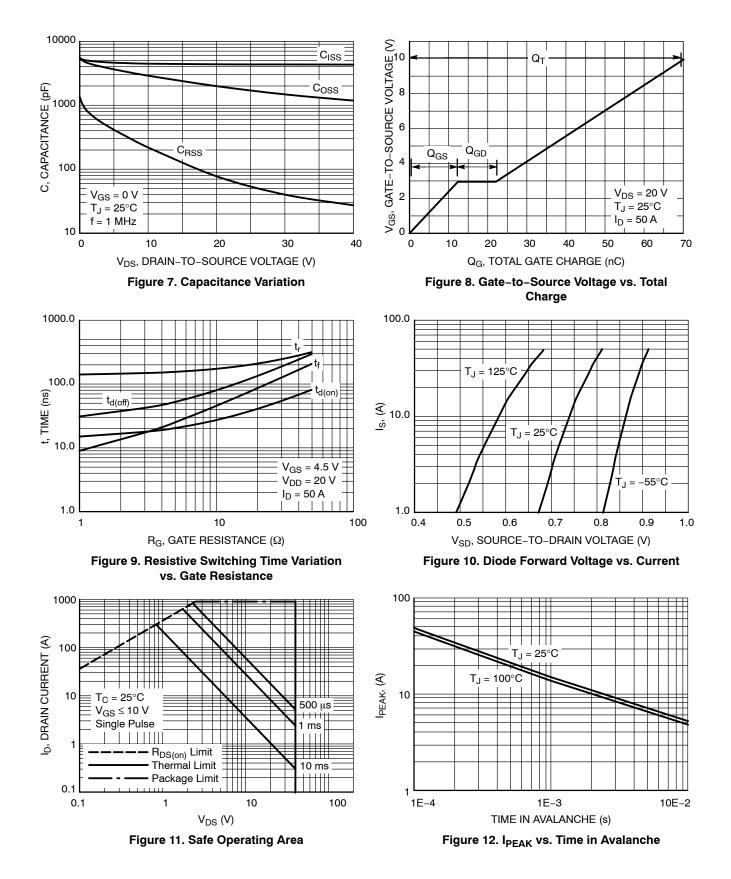
Parameter	Symbol	Test Conc	lition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				2.0		mV/°C
Zero Gate Voltage Drain Current			T _J = 25 °C			10	μA
		V _{DS} = 40 V T _J = 125°C	T _J = 125°C			250	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 130 μ A		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 50 A		1.7	2.2	mΩ
		V _{GS} = 10 V	I _D = 50 A		1.2	1.4	
Forward Transconductance	9fs	V _{DS} =15 V, I _D = 50 A			256		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 20 V			4300		pF
Output Capacitance	C _{OSS}				1900		
Reverse Transfer Capacitance	C _{RSS}				72		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 20 V; I_{D} = 50 A			32		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 20 V; I_{D} = 50 A			70		
Threshold Gate Charge	Q _{G(TH)}	V_{GS} = 4.5 V, V_{DS} = 20 V; I_{D} = 50 A			7.0		-
Gate-to-Source Charge	Q _{GS}				12		
Gate-to-Drain Charge	Q _{GD}				9.0		
Plateau Voltage	V _{GP}				2.9		V
SWITCHING CHARACTERISTICS (Note §	ō)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 20 V, I _D = 50 A, R _G = 1 Ω			15		ns
Rise Time	tr	I _D = 50 A, R	$G = 1 \Omega$		140		1
Turn-Off Delay Time	t _{d(OFF)}				31		
Fall Time	t _f				9		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$		0.81	1.2	V
			T _J = 125°C		0.68		
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dI _s /dt = 100 A/µs, I _S = 50 A			61		ns
Charge Time	t _a				29		
Discharge Time	t _b				32		
Reverse Recovery Charge	Q _{RR}				80		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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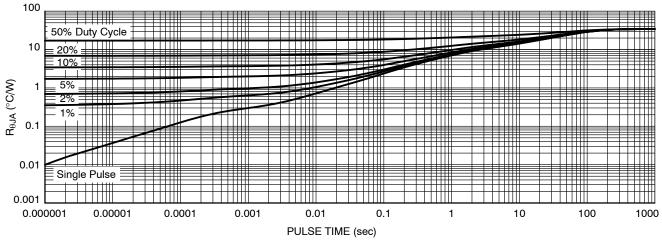


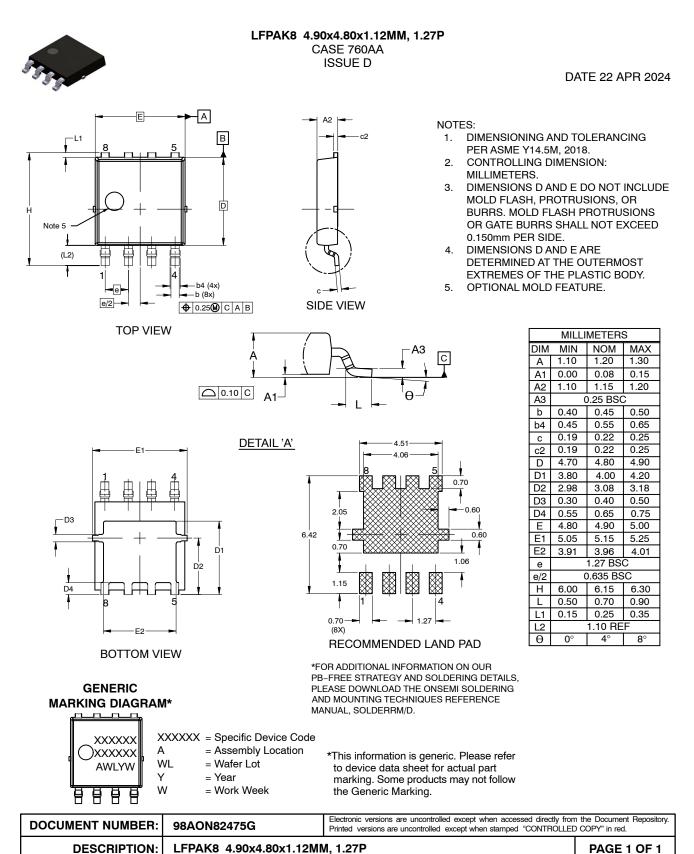
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMJS1D5N04CLTWG	1D5N04CL	LFPAK8 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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